

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takeshi Aoyagi	06/06/2005
RECEIVING PARTY DATA	
Name:	TOKYO SHINZYU CO., LTD.
Street Address:	16-3 6-chome, Ginza Chuo-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	104-0061
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	10543320
CORRESPONDENCE DATA	
Fax Number:	(817)447-9954
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	(817)447-9955
Email:	jim@waltonpllc.com
Correspondent Name:	James E. Walton
Address Line 1:	1169 N. Burleson Blvd., Suite 107-328
Address Line 4:	Burleson, TEXAS 76028
ATTORNEY DOCKET NUMBER:	1057JW-60463
NAME OF SUBMITTER:	James E. Walton
Total Attachments: 2 source=Assignment - 60463#page1.tif source=Assignment - 60463#page2.tif	

OP \$40.00 10543320

**ASSIGNMENT**  
**FOR GOOD AND VALUABLE CONSIDERATION**

I, (we) Takeshi Aoyagi

residing respectively at (city and state or country) Tokyo, Japan

do hereby sell, assign and transfer unto TOKYO SHINZYU CO., LTD.

a corporation organized under the laws of Japan  
and having an office at 16-3 6-chome, Ginza Chuo-ku  
Tokyo 104-0061, Japan

herein sometimes called "ASSIGNEE" the entire right, title and interest, together with all rights of priority, in and to my (our) invention for the IMPROVEMENT IN  
DIAMOND CUTTING METHOD AND DIAMOND PROVIDED BY THE METHOD

as described and/or claimed in my (our) application for Letters Patent of the United States of America, filed


and as described and/or claimed in any and all applications for Letters Patent based thereon including divisions, continuations and reissues thereof as well as all foreign counterparts thereof together with all Letters Patent issuing on any of the aforesaid applications for Letters Patent, the same to be held and enjoyed by ASSIGNEE, its successors, assigns or other legal representatives, to the full ends of the terms of all said Letters Patent therefore which may be granted.

AND I (WE) HEREBY AUTHORIZE ASSIGNEE to make applications for and to receive Letters Patent for said invention in any foreign countries in its own name, or in my (our) name, at its election.

AND I (WE) HEREBY COVENANTR AND AGREE that I (we) will execute or procure any further necessary assurance of title to said invention and any Letters Patent which may issue therefore and that I (we) will, at any time, upon the request and at the expense of ASSIGNEE deliver any testimony in any legal proceedings and execute all papers that may be necessary or desirable to perfect the title to said invention or any

Letters Patent which may be granted therefore in ASSIGNEE, its successors, assigns, or other legal representatives, and that I (we) will, at any time, upon the request and at the expense of ASSIGNEE execute any continuations, divisions, reissues, or any other additional applications for Letters Patent for said invention or any part or parts thereof, all of which applications and any Letters Patent issuing thereon are hereby assigned to ASSIGNEE, and will make all rightful oaths, and do all lawful acts requisite for procuring the same herein without further compensation, but at the expense of ASSIGNEE, its successors, assigns or other legal representatives.

AND I (WE) HEREBY AUTHORIZE AND REQUEST the Commissioner of Patents and Trademarks to issue any and all Letters Patent of the United States for said inventions, resulting from any of the aforesaid applications to said as sole assignee.

 2005/6/6  
Takeshi AOYAGI